

**General Description**

The SJJ60P110 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as -4.5V. This device is suitable for use as a wide variety of applications.

Features

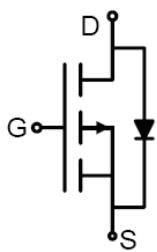
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired

Application

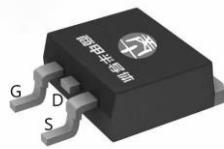
- Load Switch

Key Performance Parametes

Parameter	Value	Unit
V_{DS}	-60	V
$R_{DS(ON)}_TYP$	11.5	mΩ
I_D	-64	A
Q_G	140	nC



Schematic Diagram



TO-263 top view

Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJJ60P110	SJJ60P110	TO-263	Tape	\	\	1000 Pcs

Table 1. Absolute Maximum Ratings ($T_c=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V_{DS}	Drain-Source Voltage ($V_{GS}=0\text{V}$)	-60	V
V_{GS}	Gate-Source Voltage ($V_{DS}=0\text{V}$)	± 20	V
I_D	Drain Current-Continuous($T_c=25^\circ\text{C}$)	-64	A
	Drain Current-Continuous($T_c=100^\circ\text{C}$)	-41	A
I_{DM} (pulse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	-256	A
P_D	Maximum Power Dissipation($T_c=25^\circ\text{C}$)	96	W
	Maximum Power Dissipation($T_c=100^\circ\text{C}$)	38	W
E_{AS}	Avalanche energy (Note 2)	484	mJ
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 To 150	°C

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
$R_{θJC}$	Thermal Resistance, Junction-to-Case		1.3	°C/W



60V P-Channel Trench Power MOSFET

Table 3. Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ $I_{\text{D}}=-250\mu\text{A}$	-60			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=-60\text{V}$, $V_{\text{GS}}=0\text{V}$ $T_J=25^\circ\text{C}$			-1	μA
		$V_{\text{DS}}=-60\text{V}$, $V_{\text{GS}}=0\text{V}$ $T_J=125^\circ\text{C}$			-100	μA
I_{GSS}	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$			± 100	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{D}}=-250\mu\text{A}$	-1		-2.5	V
g_{FS}	Forward Transconductance	$V_{\text{DS}}=-5\text{V}$, $I_{\text{D}}=-20\text{A}$		38		S
$\text{R}_{\text{DS(ON)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=-10\text{V}$, $I_{\text{D}}=-15\text{A}$ $T_J=25^\circ\text{C}$		10.4	13.5	$\text{m}\Omega$
$\text{R}_{\text{DS(ON)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=-4.5\text{V}$, $I_{\text{D}}=-10\text{A}$ $T_J=25^\circ\text{C}$		14	18.6	$\text{m}\Omega$
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{\text{DS}}=-30\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1.0\text{MHz}$		8700		pF
C_{oss}	Output Capacitance			290		pF
C_{rss}	Reverse Transfer Capacitance			210		pF
Switching Parameters						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{GS}}=-10\text{V}$, $V_{\text{DS}}=-30\text{V}$, $R_{\text{L}}=1.5\Omega$, $R_{\text{GEN}}=3\Omega$		26		nS
t_{r}	Turn-on Rise Time			21		nS
$t_{\text{d(off)}}$	Turn-Off Delay Time			138		nS
t_{f}	Turn-Off Fall Time			30		nS
Q_g	Total Gate Charge	$V_{\text{GS}}=-10\text{V}$, $V_{\text{DS}}=-30\text{V}$, $I_{\text{D}}=-20\text{A}$		140		nC
Q_{gs}	Gate-Source Charge			19		nC
Q_{gd}	Gate-Drain Charge			28		nC
Source-Drain Diode Characteristics						
I_{SD}	Source-Drain Current (Body Diode)				-64	A
V_{SD}	Forward on Voltage (Note 3)	$V_{\text{GS}}=0\text{V}$, $I_{\text{S}}=-20\text{A}$			-1.2	V
t_{rr}	Reverse Recovery Time	$I_{\text{F}}=-20\text{A}$, $d\text{I}/dt=100\text{A}/\mu\text{s}$		56		ns
Q_{rr}	Reverse Recovery Charge	$I_{\text{F}}=-20\text{A}$, $d\text{I}/dt=100\text{A}/\mu\text{s}$		63		nC

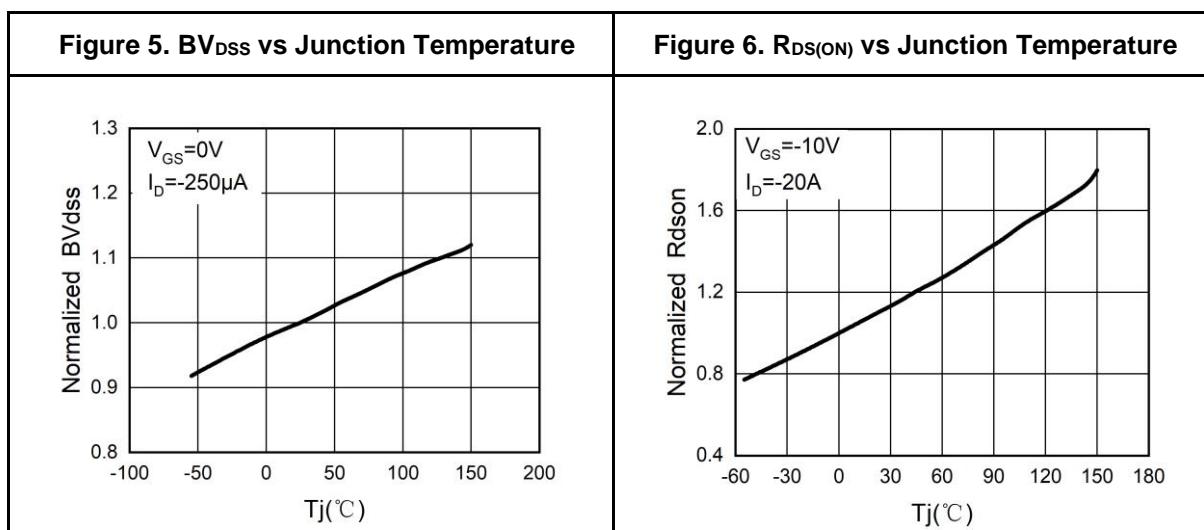
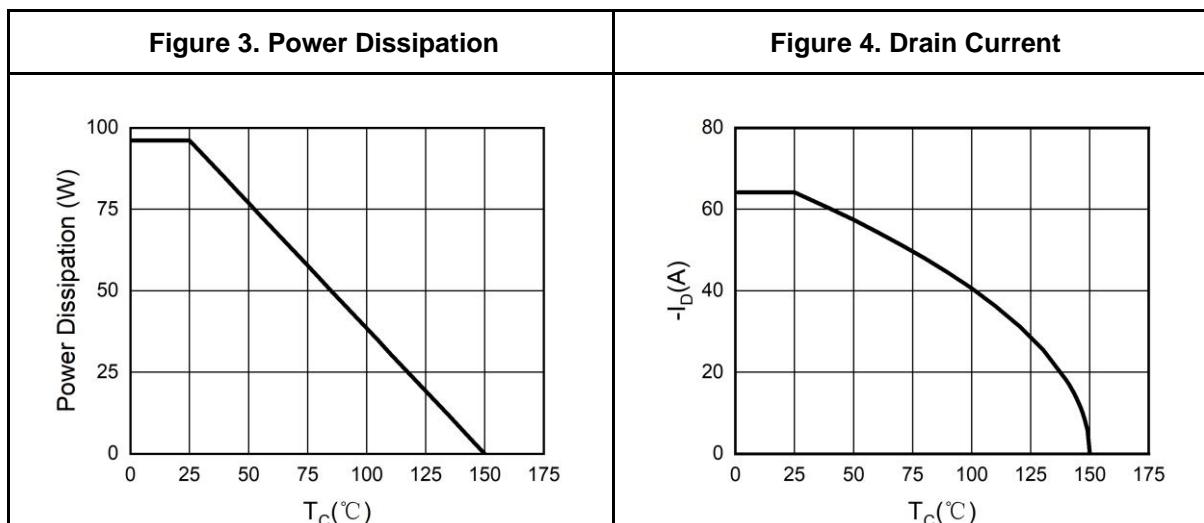
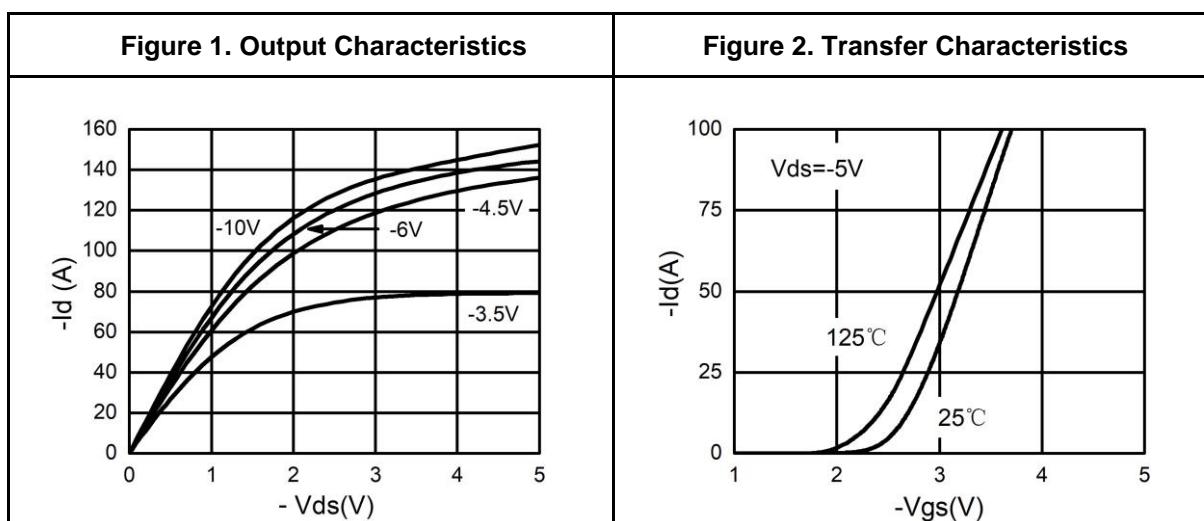
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

Notes 2.E_{AS} condition: $T_J=25^\circ\text{C}$, $V_{\text{DD}}=-40\text{V}$, $V_{\text{G}}=-10\text{V}$, $R_{\text{g}}=25\Omega$, $L=0.5\text{mH}$.

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.

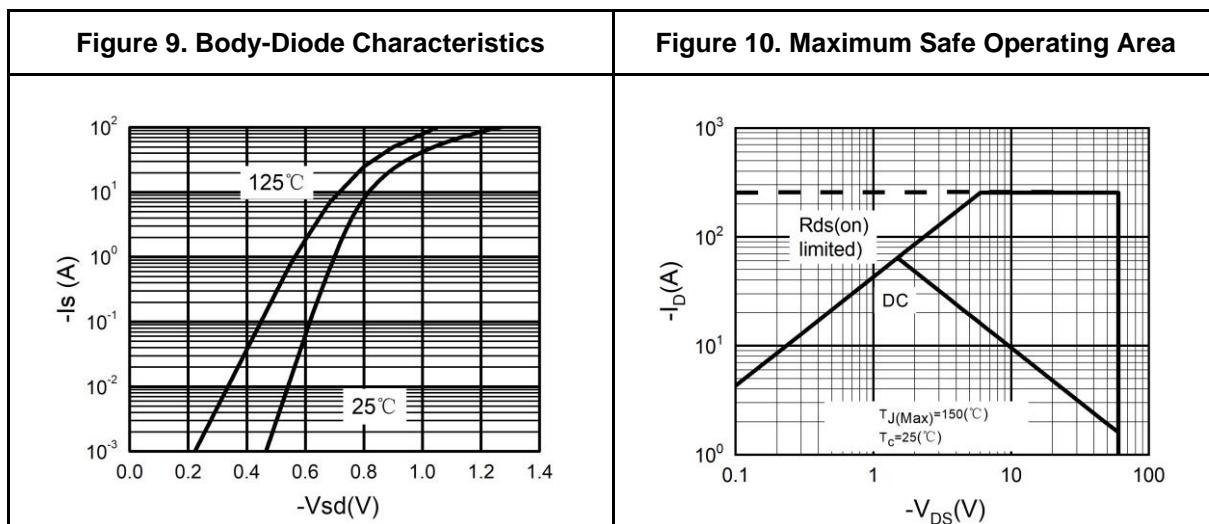
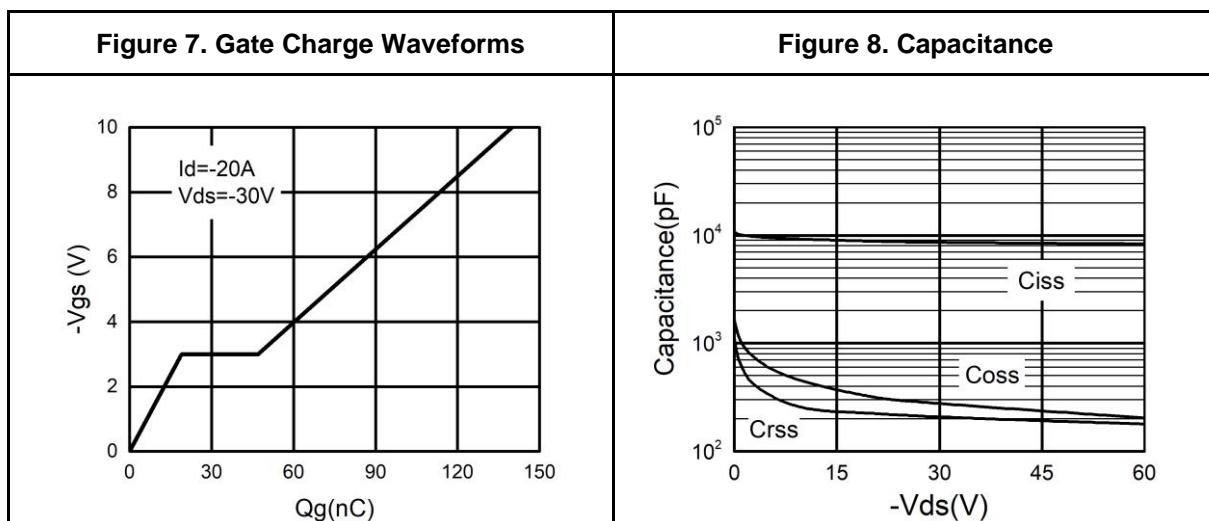


Typical Electrical And Thermal Characteristics (Curves)



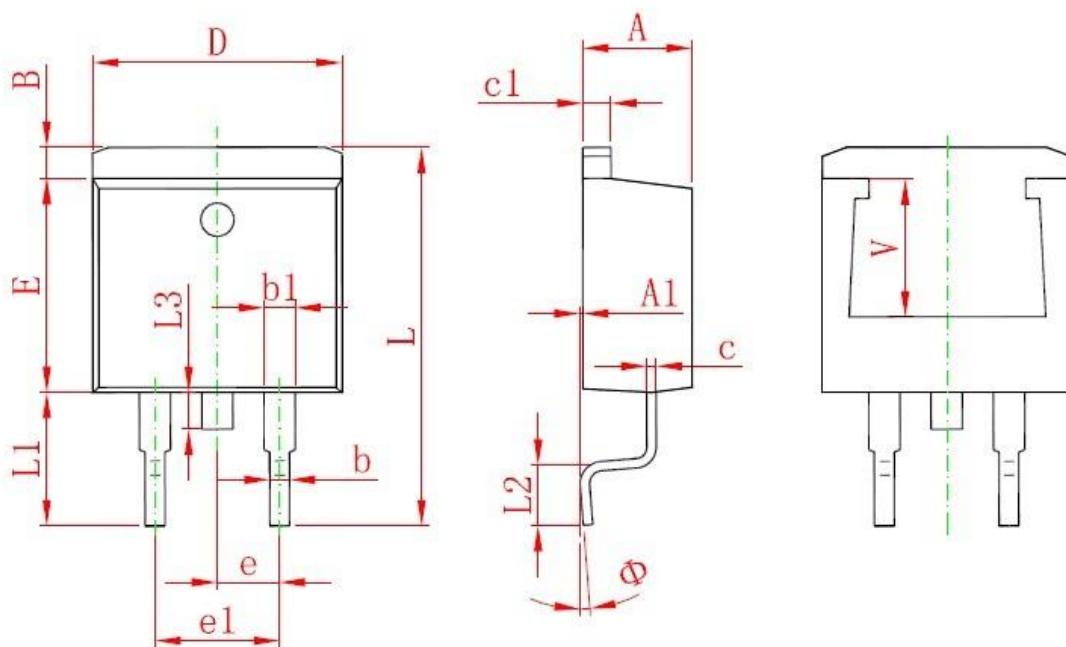


Typical Electrical And Thermal Characteristics (Curves)





TO-263 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.470	4.670	0.176	0.184
A1	0.000	0.150	0.000	0.006
B	1.120	1.420	0.044	0.056
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.310	0.530	0.012	0.021
c1	1.170	1.370	0.046	0.054
D	10.010	10.310	0.394	0.406
E	8.500	8.900	0.335	0.350
e	2.540 TYP.		0.100TYP.	
e1	4.980	5.180	0.196	0.204
L	14.940	15.500	0.588	0.610
L1	4.950	5.450	0.195	0.215
L2	2.340	2.740	0.092	0.108
L3	1.300	1.700	0.051	0.067
V	5.600 REF.		0.220REF.	
Φ	0°	8°	0°	8°



Attention

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor.

The performances and characteristics of this product in the independent testing state are displayed in this document. Wuxi Shangjia Semiconductor can't guarantee of the performances and characteristics of this described product that mounted in the customer's products or equipments as same as that in the independent testing state. So the customer should evaluate and test devices mounted in the customer's products or equipments.

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